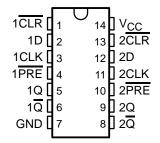
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- AC Types Feature 1.5-V to 5.5-V Operation and Balanced Noise Immunity at 30% of the Supply
- Speed of Bipolar F, AS, and S, With **Significantly Reduced Power Consumption**
- **Balanced Propagation Delays**
- ±24-mA Output Drive Current Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and **Circuit Design**
- **Exceeds 2-kV ESD Protection Per** MIL-STD-883, Method 3015

### CD54AC74...F PACKAGE CD74AC74...E OR M PACKAGE (TOP VIEW)



## description/ordering information

The 'AC74 dual positive-edge-triggered devices are D-type flip-flops.

A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs, regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the data (D) input meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not related directly to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

### ORDERING INFORMATION

| TA             | PACKAGET I |               | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|------------|---------------|--------------------------|---------------------|
|                | PDIP – E   | Tube          | CD74AC74E                | CD74AC74E           |
| –55°C to 125°C | SOIC – M   | Tube          | CD74AC74M                | AC74M               |
| -55 C to 125 C | SOIC - IVI | Tape and reel | CD74AC74M96              | AC74IVI             |
|                | CDIP – F   | Tube          | CD54AC74F3A              | CD54AC74F3A         |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

### **FUNCTION TABLE** (each flip-flop)

|     | INP | UTS        |   | OUTI  | PUTS             |
|-----|-----|------------|---|-------|------------------|
| PRE | CLR | CLK        | D | Q     | Q                |
| L   | Н   | Х          | Х | Н     | L                |
| Н   | L   | X          | Χ | L     | Н                |
| L   | L   | X          | Χ | н‡    | н‡               |
| Н   | Н   | $\uparrow$ | Н | Н     | L                |
| Н   | Н   | $\uparrow$ | L | L     | Н                |
| Н   | Н   | L          | Χ | $Q_0$ | $\overline{Q}_0$ |

<sup>‡</sup> This configuration is nonstable; that is, it does not persist when PRE or CLR returns to its inactive (high) level.



testing of all parameters.

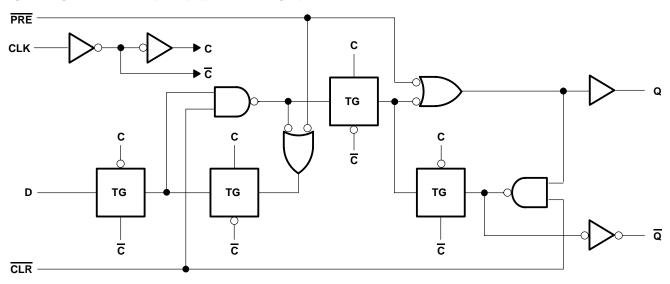
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On products compliant to MIL-PRF-38535, all parameters are tested less otherwise noted. On all other products.

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## logic diagram, each flip-flop (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>  | 0.5 V to 6 V  |
|--|---------------|
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> ) (see Note 1)  |               |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) (see Note 1) | ±50 mA        |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )   | ±50 mA        |
| Continuous current through V <sub>CC</sub> or GND  | ±100 mA       |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2): E package   | 80°C/W        |
| M package  | 86°C/W        |
| Storage temperature range, T <sub>stq</sub>  | 65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



## recommended operating conditions (see Note 3)

|                |                                    |  | T <sub>A</sub> = 25°C |      | –55°C to<br>125°C |      | –40°C to<br>85°C |      | UNIT |  |
|----------------|------------------------------------|--|-----------------------|------|-------------------|------|------------------|------|------|--|
|                |                                    | M  |                       | MAX  | MIN               | MAX  | MIN              | MAX  |      |  |
| Vсс            | Supply voltage                     |  | 1.5                   | 5.5  | 1.5               | 5.5  | 1.5              | 5.5  | V    |  |
|                |                                    | V <sub>CC</sub> = 1.5 V                    | 1.2                   |      | 1.2               |      | 1.2              |      |      |  |
| ٧ıH            | High-level input voltage           | V <sub>CC</sub> = 3 V                      | 2.1                   |      | 2.1               |      | 2.1              |      | V    |  |
|                |                                    | V <sub>CC</sub> = 5.5 V                    | 3.85                  |      | 3.85              |      | 3.85             |      |      |  |
|                |                                    | V <sub>CC</sub> = 1.5 V                    |                       | 0.3  |                   | 0.3  |                  | 0.3  |      |  |
| VIL            | Low-level input voltage            | V <sub>CC</sub> = 3 V                      |                       | 0.9  |                   | 0.9  |                  | 0.9  | V    |  |
|                |                                    | V <sub>CC</sub> = 5.5 V                    |                       | 1.65 |                   | 1.65 |                  | 1.65 |      |  |
| ٧ <sub>I</sub> | Input voltage                      |  | 0                     | VCC  | 0                 | VCC  | 0                | VCC  | V    |  |
| ۷o             | Output voltage                     |  | 0                     | VCC  | 0                 | VCC  | 0                | VCC  | V    |  |
| ІОН            | High-level output current          | V <sub>CC</sub> = 4.5 V to 5.5 V           |                       | -24  |                   | -24  |                  | -24  | mA   |  |
| loL            | Low-level output current           | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |                       | 24   |                   | 24   |                  | 24   | mA   |  |
| Δt/Δν          | Input transition rise or fall rate | $V_{CC} = 1.5 \text{ V to 3 V}$            |                       | 50   |                   | 50   |                  | 50   |      |  |
| ΔψΔV           | Input transition rise or fall rate | $V_{CC} = 3.6 \text{ V to } 5.5 \text{ V}$ |                       | 20   |                   | 20   |                  | 20   | ns/V |  |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS                   |                                      | Vcc   | T <sub>A</sub> = 25°C | –55°0<br>125° |      | –40°C to<br>85°C |      | UNIT |
|-----------|-----------------------------------|--------------------------------------|-------|-----------------------|---------------|------|------------------|------|------|
|           |                                   |                                      |       | MIN MAX               | MIN           | MAX  | MIN              | MAX  |      |
|           |                                   |                                      | 1.5 V | 1.4                   | 1.4           |      | 1.4              |      |      |
|           |                                   | I <sub>OH</sub> = -50 μA             | 3 V   | 2.9                   | 2.9           |      | 2.9              |      |      |
|           |                                   |                                      | 4.5 V | 4.4                   | 4.4           |      | 4.4              |      |      |
| Voн       | $V_I = V_{IH}$ or $V_{IL}$        | $I_{OH} = -4 \text{ mA}$             | 3 V   | 2.58                  | 2.4           |      | 2.48             |      | V    |
|           |                                   | $I_{OH} = -24 \text{ mA}$            | 4.5 V | 3.94                  | 3.7           |      | 3.8              |      |      |
|           |                                   | $I_{OH} = -50 \text{ mA}^{\dagger}$  | 5.5 V |                       | 3.85          |      |                  |      |      |
|           |                                   | $I_{OH} = -75 \text{ mA}^{\dagger}$  | 5.5 V |                       |               |      | 3.85             |      |      |
|           |                                   |                                      | 1.5 V | 0.1                   |               | 0.1  |                  | 0.1  |      |
|           |                                   | I <sub>OL</sub> = 50 μA              | 3 V   | 0.1                   |               | 0.1  |                  | 0.1  |      |
|           |                                   |                                      | 4.5 V | 0.1                   |               | 0.1  |                  | 0.1  |      |
| $V_{OL}$  | $V_I = V_{IH} \text{ or } V_{IL}$ | I <sub>OL</sub> = 12 mA              | 3 V   | 0.36                  | 5             | 0.5  |                  | 0.44 | V    |
|           |                                   | I <sub>OL</sub> = 24 mA              | 4.5 V | 0.36                  | 5             | 0.5  |                  | 0.44 |      |
|           |                                   | I <sub>OL</sub> = 50 mA†             | 5.5 V |                       |               | 1.65 |                  |      |      |
|           |                                   | I <sub>OL</sub> = 75 mA <sup>†</sup> | 5.5 V |                       |               |      |                  | 1.65 |      |
| IĮ        | $V_I = V_{CC}$ or GND             | -                                    | 5.5 V | ±0.′                  |               | ±1   |                  | ±1   | μΑ   |
| ICC       | $V_I = V_{CC}$ or GND,            | IO = 0                               | 5.5 V | 4                     |               | 80   |                  | 40   | μΑ   |
| Ci        |                                   |                                      |       | 10                    | )             | 10   |                  | 10   | pF   |

<sup>†</sup> Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.



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# timing requirements over recommended operating free-air temperature range, $V_{CC} = 1.5 \text{ V}$ (unless otherwise noted)

|                  |                            |                     | –55°(<br>125 |     | –40°C to<br>85°C |     | UNIT |  |
|------------------|----------------------------|---------------------|--------------|-----|------------------|-----|------|--|
|                  |                            |                     | MIN          | MAX | MIN              | MAX |      |  |
| fclock           | Clock frequency            |                     |              | 9   |                  | 10  | MHz  |  |
|                  | Pulse duration             | PRE or CLR low      | 50           |     | 44               |     | ns   |  |
| t <sub>W</sub>   |                            | CLK                 | 56           |     | 49               |     | 115  |  |
| +                | Catus time                 | Data                | 44           |     | 39               |     | ns   |  |
| t <sub>su</sub>  | Setup time                 | PRE or CLR inactive |              |     |                  |     | ns   |  |
| t <sub>h</sub>   | Hold time                  | Data after CLK↑     | 0            |     | 0                |     | ns   |  |
| t <sub>rec</sub> | Recovery time, before CLK↑ | CLR↑ or PRE↑        | 34           |     | 30               |     | ns   |  |

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

|                  |                            |                     | –55°0<br>125 |    | –40°C to<br>85°C |     | UNIT |  |
|------------------|----------------------------|---------------------|--------------|----|------------------|-----|------|--|
|                  |                            |                     | MIN MA       |    | MIN              | MAX |      |  |
| fclock           | Clock frequency            |                     |              | 79 |                  | 90  | MHz  |  |
|                  | Pulse duration             | PRE or CLR low      | 5.6          |    | 4.9              |     | ns   |  |
| t <sub>W</sub>   | Pulse duration             | CLK                 | 6.3          |    | 5.5              |     | 115  |  |
|                  | Cotup time                 | Data                | 4.9          |    | 4.3              |     | ns   |  |
| t <sub>su</sub>  | Setup time                 | PRE or CLR inactive |              |    |                  |     | ns   |  |
| t <sub>h</sub>   | Hold time                  | Data after CLK↑     | 0            |    | 0                |     | ns   |  |
| t <sub>rec</sub> | Recovery time, before CLK↑ | CLR↑ or PRE↑        | 4.7          |    | 4.1              |     | ns   |  |

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

|                  |                            |                     | –55°<br>125 |     | –40°C to<br>85°C |     | UNIT |
|------------------|----------------------------|---------------------|-------------|-----|------------------|-----|------|
|                  |                            |                     | MIN         | MAX | MIN              | MAX |      |
| fclock           | Clock frequency            |                     |             | 110 |                  | 125 | MHz  |
|                  | Pulse duration             | PRE or CLR low      | 4           |     | 3.5              |     | ns   |
| t <sub>W</sub>   | Pulse duration             | CLK                 | 4.5         |     | 3.9              |     | 115  |
| +                | Cotup time                 | Data                | 3.5         |     | 3.1              |     | ns   |
| t <sub>su</sub>  | Setup time                 | PRE or CLR inactive |             |     |                  |     | ns   |
| t <sub>h</sub>   | Hold time                  | Data after CLK↑     | 0           |     | 0                |     | ns   |
| t <sub>rec</sub> | Recovery time, before CLK↑ | CLR↑ or PRE↑        | 2.7         | ·   | 2.4              |     | ns   |

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 1.5 V, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)                  | –55°C to<br>125°C |     |                                |     | UNIT |
|------------------|-----------------|---------------------------------|-------------------|-----|--------------------------------|-----|------|
|                  | (1141 01)       | (0011 01)                       | MIN               | MAX | 85°C<br>MIN MA<br>10<br>1<br>1 | MAX |      |
| f <sub>max</sub> |                 |                                 | 9                 |     | 10                             |     | MHz  |
| t <sub>PLH</sub> | Q1.K            | 0 x x <del>0</del>              |                   | 125 |                                | 114 | 20   |
| t <sub>PHL</sub> | CLK             | ${\sf Q}$ or $\overline{\sf Q}$ |                   | 125 |                                | 114 | ns   |
| t <sub>PLH</sub> | PRE or CLR      | Q or $\overline{\mathbb{Q}}$    |                   | 132 |                                | 120 | ne   |
| t <sub>PHL</sub> | PRE OF CER      | QorQ                            |                   | 144 |                                | 131 | ns   |

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | –55°(<br>125 |      | –40°0<br>85° | UNIT |     |
|------------------|-----------------|----------------|--------------|------|--------------|------|-----|
|                  | (1141 01)       | (0011 01)      | MIN          | MAX  | MIN          | MAX  |     |
| f <sub>max</sub> |                 |                | 79           |      | 90           |      | MHz |
| t <sub>PLH</sub> | CLK             | 0 0            | 3.5          | 14   | 3.6          | 12.7 | ns  |
| t <sub>PHL</sub> | CLK             | Q or Q         | 3.5          | 14   | 3.6          | 12.7 | 115 |
| tPLH             | PRE or CLR      | 0 or 0         | 3.7          | 14.7 | 3.8          | 13.4 | ne  |
| <sup>t</sup> PHL | FRE UI CER      | Q or Q         | 4            | 16.1 | 4.1          | 14.6 | ns  |

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

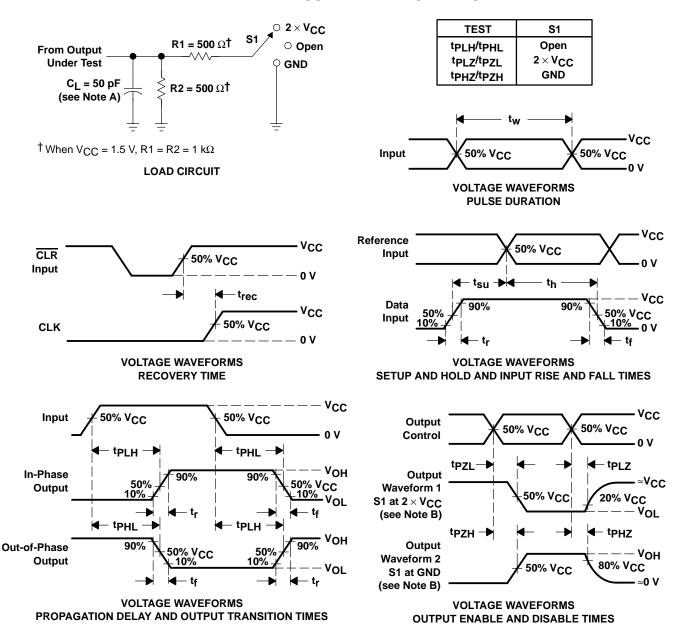
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)               | –55°C to<br>125°C |      | –40°C to<br>85°C |      | UNIT |
|------------------|-----------------|------------------------------|-------------------|------|------------------|------|------|
|                  | (1141 01)       | (0011 01)                    | MIN               | MAX  | 125<br>10 2.6    | MAX  |      |
| f <sub>max</sub> |                 |                              | 110               |      | 125              |      | MHz  |
| tPLH             | OLK.            | 0                            | 2.5               | 10   | 2.6              | 9.1  | no   |
| t <sub>PHL</sub> | CLK             | Q or Q                       | 2.5               | 10   | 2.6              | 9.1  | ns   |
| tPLH             | PRE or CLR      | Q or $\overline{\mathbb{Q}}$ | 2.6               | 10.5 | 2.7              | 9.5  | 20   |
| <sup>t</sup> PHL | FRE OI CER      | Q 61 Q                       | 2.9               | 11.5 | 3                | 10.4 | ns   |

## operating characteristics, T<sub>A</sub> = 25°C

|   |                 | PARAMETER                     | TYP | UNIT |
|---|-----------------|-------------------------------|-----|------|
| I | C <sub>pd</sub> | Power dissipation capacitance | 55  | pF   |



### PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z<sub>Ω</sub> = 50 Ω, t<sub>f</sub> = 3 ns, t<sub>f</sub> = 3 ns. Phase relationships between waveforms are arbitrary.
  - D. For clock inputs, f<sub>max</sub> is measured with the input duty cycle at 50%.
  - E. The outputs are measured one at a time with one input transition per measurement.
  - F. tpLH and tpHL are the same as tpd.
  - G. tpz and tpzH are the same as ten.
  - H. tpLz and tpHz are the same as tdis.

Figure 1. Load Circuit and Voltage Waveforms



### 14 LEADS SHOWN



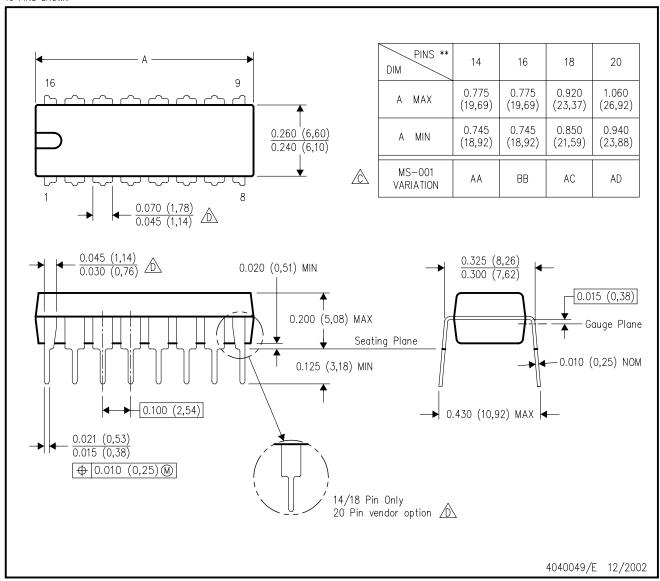
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



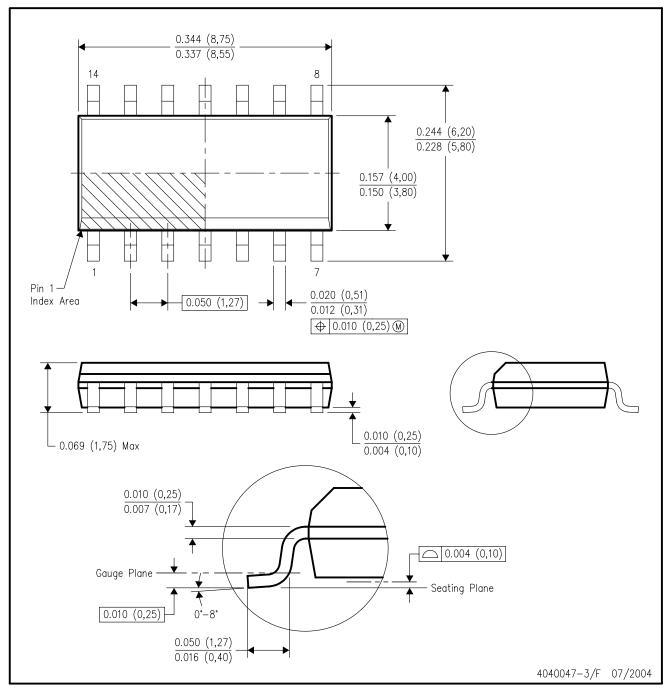
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



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